

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	BSZ067N06LS3 G	**Issued**	17. February 2022
MA#	MA005698195		
Package	PG-TSDSON-8-2	**Weight***	38.76 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.835	4.73	4.73	47344	47344
leadframe	inorganic material	phosphorus	7723-14-0	0.002	0.01		54	
	non noble metal	zinc	7440-66-6	0.008	0.02		216	
	non noble metal	iron	7439-89-6	0.168	0.43		4326	
	non noble metal	copper	7440-50-8	6.808	17.57	18.03	175654	180250
wire	non noble metal	copper	7440-50-8	0.035	0.09	0.09	913	913
encapsulation	organic material	carbon black	1333-86-4	0.034	0.09		868	
	plastics	epoxy resin	-	1.733	4.47		44727	
	inorganic material	silicondioxide	60676-86-0	15.063	38.87	43.43	388648	434243
leadfinish	non noble metal	tin	7440-31-5	0.387	1.00	1.00	9989	9989
plating	noble metal	silver	7440-22-4	0.963	2.48	2.48	24837	24837
solder	non noble metal	tin	7440-31-5	0.037	0.10		950	
	noble metal	silver	7440-22-4	0.046	0.12		1187	
	non noble metal	lead	7439-92-1	1.758	4.54	4.76	45351	47488
heat sink clip	inorganic material	phosphorus	7723-14-0	0.002			49	
	non noble metal	zinc	7440-66-6	0.008	0.02		195	
	non noble metal	iron	7439-89-6	0.151	0.39		3894	
	non noble metal	copper	7440-50-8	6.127	15.81	16.22	158096	162234
heatspreader	inorganic material	phosphorus	7723-14-0	0.001			28	
	non noble metal	zinc	7440-66-6	0.004	0.01		111	
	non noble metal	iron	7439-89-6	0.086	0.22		2225	
	non noble metal	copper	7440-50-8	3.501	9.03	9.26	90338	92702
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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